

FEE TRANSMITTAL

Electronic Version v08

Stylesheet Version v08.0

Title of Invention	Method of Manufacturing a Semiconductor Device and a Method for Fixing the Semiconductor Device Using Substrate Jig
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Application Number :

Date :

First Named Applicant: Kazuo TESHIROGI

Attorney Docket Number: 020334A

TOTAL FEE AUTHORIZED \$ 856

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

BASIC FILING FEE

Fee Description	Fee Code	Amount \$	Fee Paid \$
Utility Filing Fee	1001	770	770
Subtotal For Basic Filing Fees: \$ 770			

EXTRA CLAIM FEES

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 6	0	1202	18	0
Independent Claims : 4	1	1201	86	86
Subtotal For Extra Claims Fees: \$ 86				

AUTHORIZED BILLING INFORMATION

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Deposit account number:	012340
Access Code	****
Deposit name:	Armstrong Kratz Quintos Hanson Brooks LLP
Deposit authorized name:	William G. Kratz Jr.
Signature:	/WGK/
Date (YYYYMMDD):	2004-02-06